

Composite Desoldering Tip SOP 8L - Hakko T8-1006

Item no. HK-T8-1006

Manufacturer Hakko

EAN 4962615010019

Composite desoldering tip in SOP 8L format designed for use with the Hakko FM 2022 parallel desoldering tweezers. Enables precise removal of surface-mount components. Supplied as a pack of 2 tips.

TECHNICAL DATA

Country of Manufacture	Japan
HS-Code	85159080
Weight	0.1 kg

DESCRIPTION

OVERVIEW

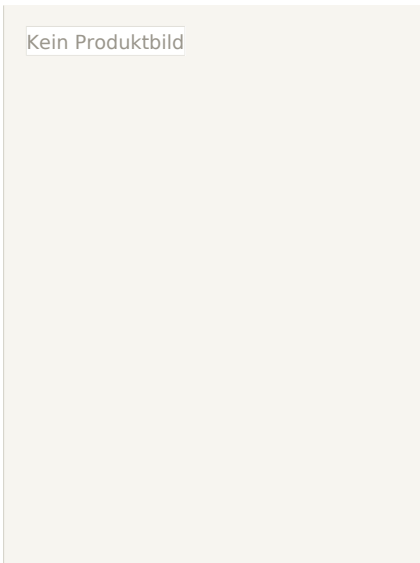
The Hakko T8-1006 is a composite desoldering tip specifically engineered for the FM 2022 parallel desoldering tweezers system. Designed in SOP 8L format, this tip enables precise and efficient removal of surface-mount integrated circuits and other small outline package components from PCBs without damaging surrounding circuitry.

KEY FEATURES

- SOP 8L format geometry for optimal component alignment
- Composite construction for enhanced durability and thermal performance
- Compatible exclusively with FM 2022 parallel desoldering tweezers
- Enables simultaneous heating of all component leads
- Reduces thermal stress on PCB and adjacent components
- Pack of 2 tips for extended operational use

TECHNICAL SPECIFICATIONS

Tip Format	SOP 8L
Compatible Equipment	FM 2022 Parallel Desoldering Tweezers
Material	Composite
Quantity per Pack	2 pieces
Country of Origin	Japan



APPLICATIONS

Ideal for rework and repair operations involving small outline package (SOP) integrated circuits, particularly 8-lead SOP components. Commonly used in electronics manufacturing, PCB assembly, and component-level repair where precision and minimal thermal impact are critical.

SCOPE OF DELIVERY

- 2 × Composite Desoldering Tip SOP 8L Format